

March 2013

# FDA59N30 N-Channel UniFET<sup>TM</sup> MOSFET

# **FDA59N30** N-Channel UniFET<sup>TM</sup> MOSFET 300 V, 59 A, 56 mΩ

### Features

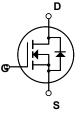
- +  $R_{DS(on)}$  = 56 m $\Omega$  (Max.) @  $V_{GS}$  = 10 V, I<sub>D</sub> = 29.5 A
- Low Gate Charge (Typ. 77 nC)
- Low C<sub>rss</sub> (Typ. 80 pF)
- 100% Avalanche Tested

# Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

# Description

UniFET<sup>TM</sup> MOSFET is Fairchild Semiconductor<sup>®</sup>'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



# Absolute Maximum Ratings

G v

Symbol	Parameter			FDA59N30	Unit
V <sub>DSS</sub>	Drain-Source Voltage			300	V
ID	Drain Current	- Continuous (T <sub>C</sub> = 25°C) - Continuous (T <sub>C</sub> = 100°C)		59 35	A A
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	236	A
V <sub>GSS</sub>	Gate-Source voltage			±30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	1734	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	59	A
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	50	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C) - Derate above 25°C		500 4	W W/°C
T <sub>J,</sub> T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	۵°
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		se,	300	°C

TO-3PN

# **Thermal Characteristics**

Symbol	Parameter	FDA59N30	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.25	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	C/W

FDA59N30
<b>N-Channel</b>
UniFET <sup>TM</sup>
MOSFET

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDA59N30	FDA59N30	TO-3PN	-	-	30

### Electrical Characteristics T<sub>c</sub> = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Unit
Off Charac	teristics			1		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	xdown Voltage $V_{GS} = 0V, I_D = 250\mu A$				V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C		0.3		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 300V, V_{GS} = 0V$ $V_{DS} = 240V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V			-100	nA
On Charac	teristics	•				
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 29.5A		0.047	0.056	Ω
9 <sub>FS</sub>	Forward Transconductance	Fransconductance $V_{DS} = 40V, I_D = 29.5A$		52		S
Dynamic C	haracteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,		3590	4670	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0MHz		710	920	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			80	120	pF
Switching	Characteristics	•				
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 150V, I <sub>D</sub> = 59A		140	290	ns
t <sub>r</sub>	Turn-On Rise Time	$R_{G} = 25\Omega$		575	1160	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			120	250	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		200	410	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 240V, I <sub>D</sub> = 59A		77	100	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10V		22		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)		40		nC
Drain-Sou	rce Diode Characteristics and Maximur	n Ratings				<u></u>
I <sub>S</sub> Maximum Continuous Drain-Source Diode Forward Current					59	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				236	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 59A			1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>S</sub> = 59A		246		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt =100A/μs		6.9		μC

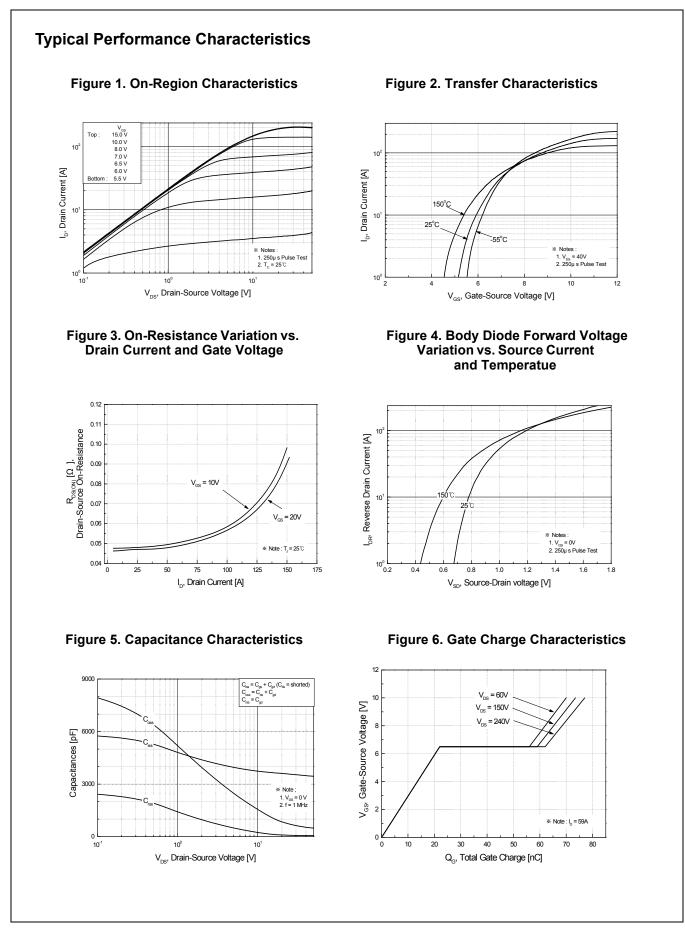
#### NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

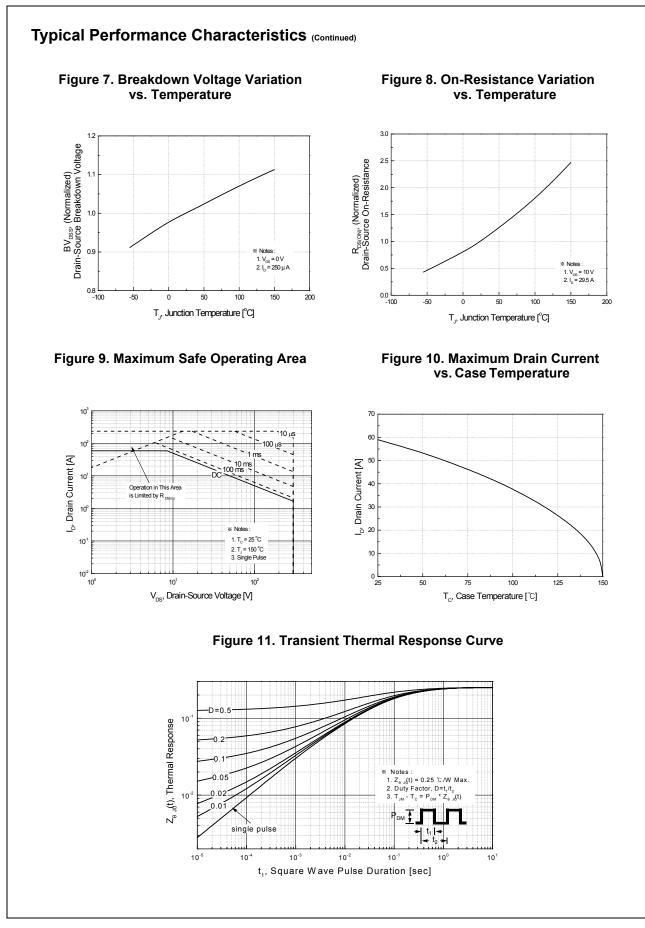
2. L = 0.83mH, I\_{AS} = 59A, V\_{DD} = 50V, R\_G = 25 $\Omega$ , Starting T\_J = 25°C

3.  $I_{SD} \leq$  59A, di/dt  $\leq$  200A/µs,  $V_{DD} \leq BV_{DSS},$  Starting  $T_J$  = 25°C

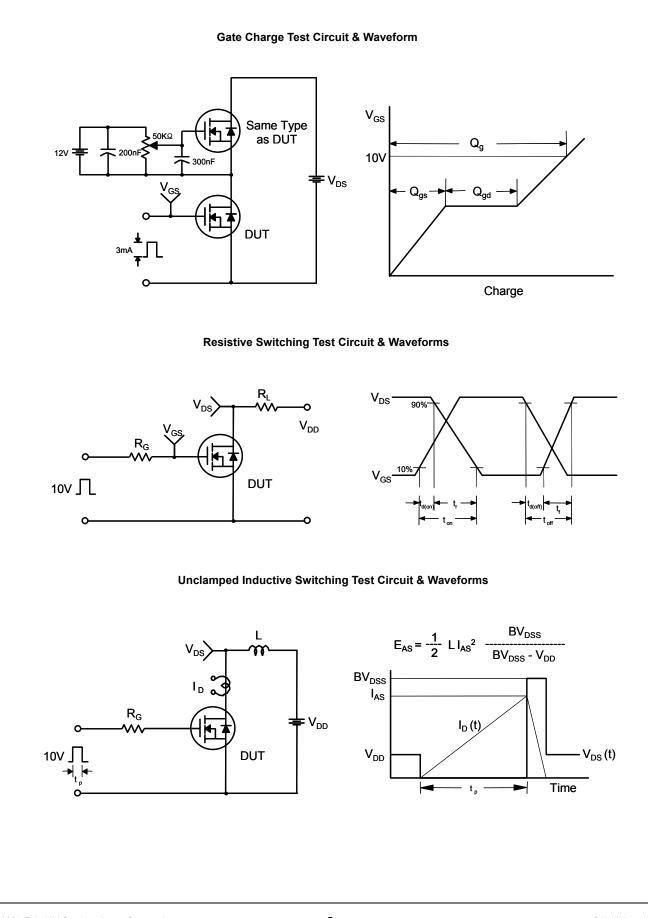
4. Essentially Independent of Operating Temperature Typical Characteristics



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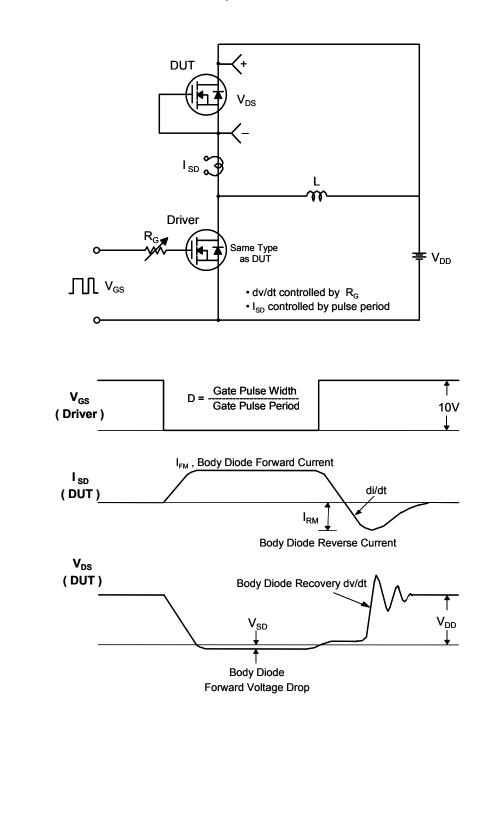


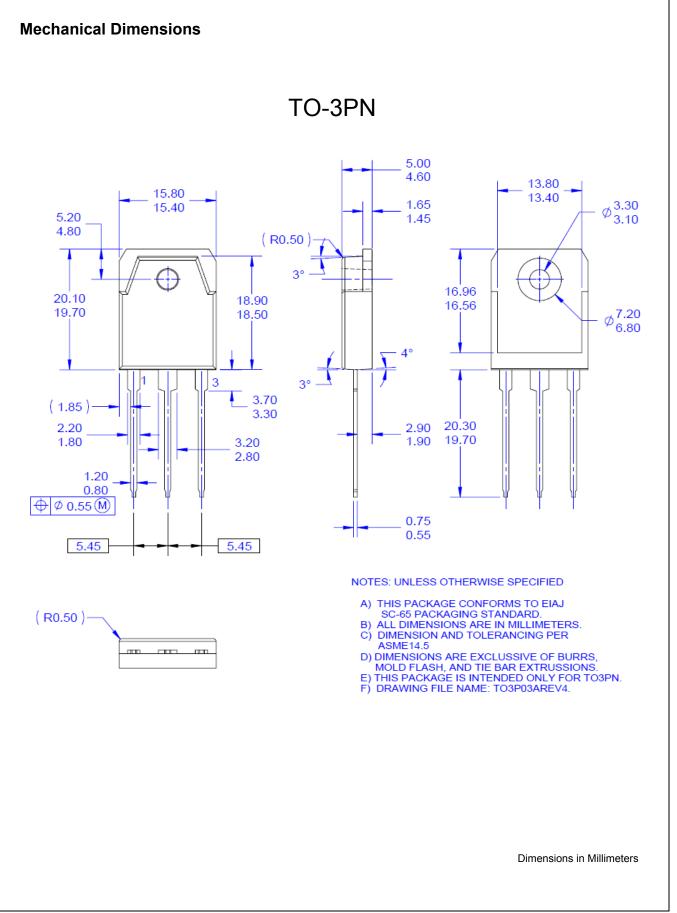
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#### Peak Diode Recovery dv/dt Test Circuit & Waveforms







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